



Click [here](#) for the 3D model.

Dimensions

Chip Size	1825
L	4.57mm +0.38/-0.51mm (0.18 in +0.015/-0.02 in)
W	6.35mm +0.38/-0.51mm (0.25 in +0.015/-0.02 in)
T	1.27mm +/-0.76mm (0.05 in +/-0.03 in)
B	0.51mm +/-0.25mm (0.02 in +/-0.01 in)

Packaging Specifications

Packaging	T&R, 178mm, Plastic Tape
Packaging Quantity	1100

General Information

Series	SMD Mil PRF55681
Style	SMD Chip
RoHS	No
Prop 65	⚠ WARNING: Cancer and reproductive harm - http://www.p65warnings.ca.gov .
SCIP Number	1c00297e-7f97-4ed1-8a7f-4c4644e8ab84
Termination	Lead (SnPb)
Failure Rate	P (0.1%/1000 Hrs)
Testing and Reliability	MIL-PRF-55681
Qualifications	MIL-PRF-55681
AEC-Q200	No
Miscellaneous	Termination Description: SolderPlate 70-30.
Shelf Life	78 Weeks
MSL	1

Specifications

Capacitance	0.1 uF
Capacitance Tolerance	10%
Voltage DC	100 VDC
Temperature Range	-55/+125°C
Temperature Coefficient	BX

Statements of suitability for certain applications are based on our knowledge of typical operating conditions for such applications, but are not intended to constitute - and we specifically disclaim - any warranty concerning suitability for a specific customer application or use. This information is intended for use only by customers who have the requisite experience and capability to determine the correct products for their application. Any technical advice inferred from this information or otherwise provided by us with reference to the use of our products is given gratis, and we assume no obligation or liability for the advice given or results obtained.

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